

| Parameter | Value |
|---------------|--------------|
| V_{CC} | -50V |
| $I_{C(MAX.)}$ | -500mA |
| R_1 | 1k Ω |
| R_2 | 10k Ω |

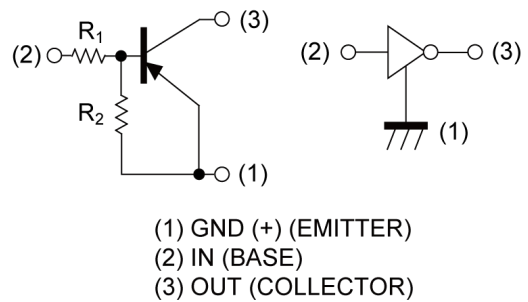
●Outline



●Features

- 1) Built-In Biasing Resistors,
 $R_1 = 1.0k\Omega$, $R_2 = 10k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Type: DTD113ZC HZG

●Inner circuit



●Application

INVERTER, INTERFACE, DRIVER

●Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|--------------|---------------|--------------|-------------|----------------|-----------------|---------------------------|---------|
| DTB113ZC HZG | SOT-23 (SST3) | 2924 | T116 | 180 | 8 | 3000 | G11 |

● **Absolute maximum ratings** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Values | Unit |
|------------------------------|-------------------|-------------|------------------|
| Supply voltage | V_{CC} | -50 | V |
| Input voltage | V_{IN} | -10 to 5 | V |
| Collector current | $I_{C(MAX)}^{*1}$ | -500 | mA |
| Power dissipation | P_D^{*2} | 200 | mW |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Range of storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

● **Electrical characteristics** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|----------------------|--------------|---|--------|------|------|------------|
| | | | Min. | Typ. | Max. | |
| Input voltage | $V_{I(off)}$ | $V_{CC} = -5V, I_O = -100\mu\text{A}$ | - | - | -0.3 | V |
| | $V_{I(on)}$ | $V_O = -0.3V, I_O = -20\text{mA}$ | -3.0 | - | - | |
| Output voltage | $V_{O(on)}$ | $I_O = -50\text{mA}, I_I = -2.5\text{mA}$ | - | -100 | -300 | mV |
| Input current | I_I | $V_I = -5V$ | - | - | -7.2 | mA |
| Output current | $I_{O(off)}$ | $V_{CC} = -50V, V_I = 0V$ | - | - | -500 | nA |
| DC current gain | G_I^{*3} | $V_O = -5V, I_O = -50\text{mA}$ | 56 | - | - | - |
| Input resistance | R_1 | - | 0.7 | 1 | 1.3 | k Ω |
| Resistance ratio | R_2/R_1 | - | 8 | 10 | 12 | - |
| Transition frequency | f_T^{*1} | $V_{CE} = -10V, I_E = 50\text{mA}, f = 100\text{MHz}$ | - | 200 | - | MHz |

*1 Characteristics of built-in transistor

*2 Each terminal mounted on a reference land.

*3 Pulsed

● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

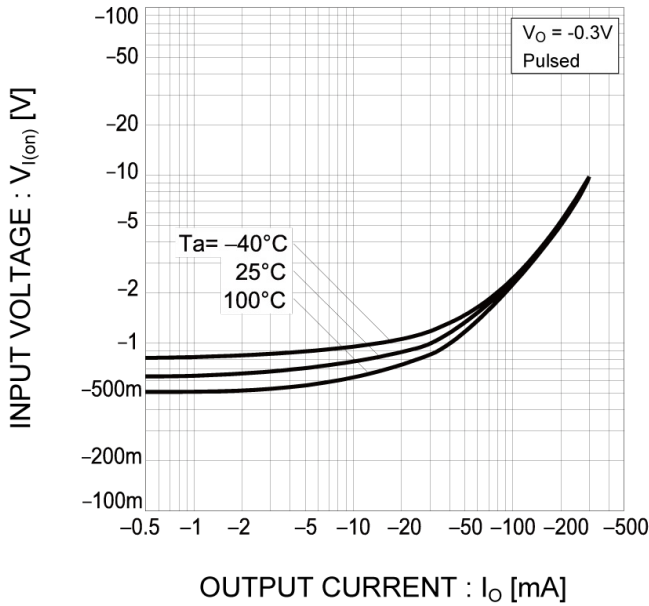


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

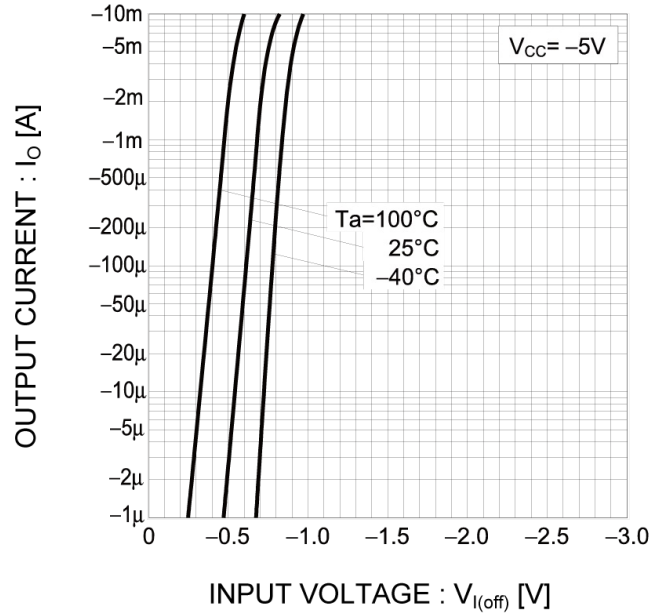


Fig.3 Output Current vs. Output Voltage

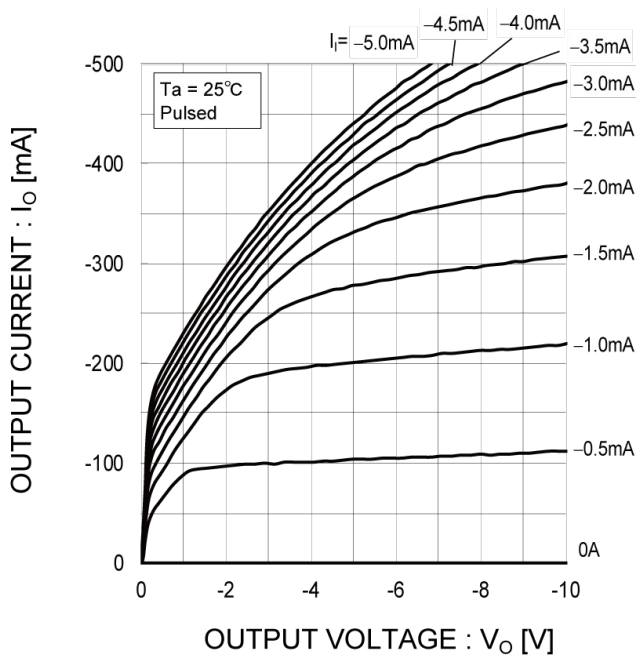
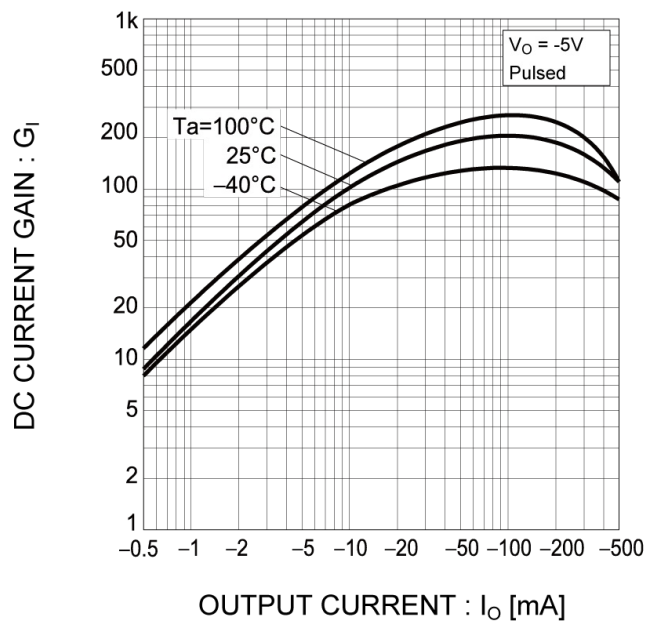
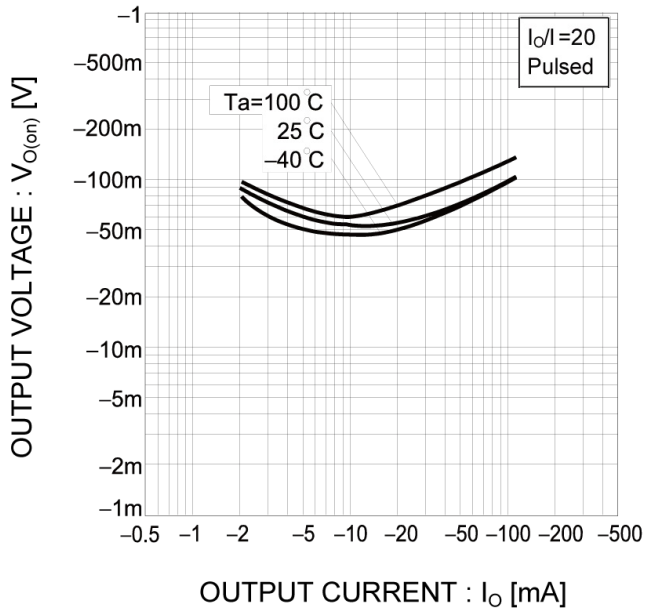


Fig.4 DC Current Gain vs. Output Current



● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.5 Output Voltage vs. Output Current



●Dimensions

SOT-23
(SST3)



Pattern of terminal position areas
[Not a pattern of soldering pads]

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.90 | 1.20 | 0.035 | 0.047 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A2 | 0.85 | 1.15 | 0.033 | 0.045 |
| A3 | 0.25 | | 0.010 | |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| c | 0.09 | 0.25 | 0.004 | 0.010 |
| D | 2.70 | 3.10 | 0.106 | 0.122 |
| E | 1.20 | 1.50 | 0.047 | 0.059 |
| e | 0.95 | | 0.037 | |
| HE | 2.20 | 2.60 | 0.087 | 0.102 |
| L1 | 0.20 | - | 0.008 | - |
| Lp | 0.30 | - | 0.012 | - |
| Q | 0.40 | 0.60 | 0.016 | 0.024 |
| x | - | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| b2 | - | 0.60 | - | 0.024 |
| e1 | 1.70 | | 0.067 | |
| l1 | - | 0.90 | - | 0.035 |

Dimension in mm/inches

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV | | CLASS III | |

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
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 - [h] Use of the Products in places subject to dew condensation
4. The Products are not subject to radiation-proof design.
5. Please verify and confirm characteristics of the final or mounted products in using the Products.
6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

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 - [d] the Products are exposed to high Electrostatic
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3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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